

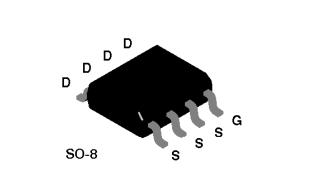
# NDS9430A Single P-Channel Enhancement Mode Field Effect Transistor

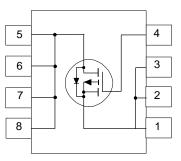
#### **General Description**

These P-Channel enhancement mode power field effect transistors are produced using National's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

### Features

- High density cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handling capability in a widely used surface mount package.





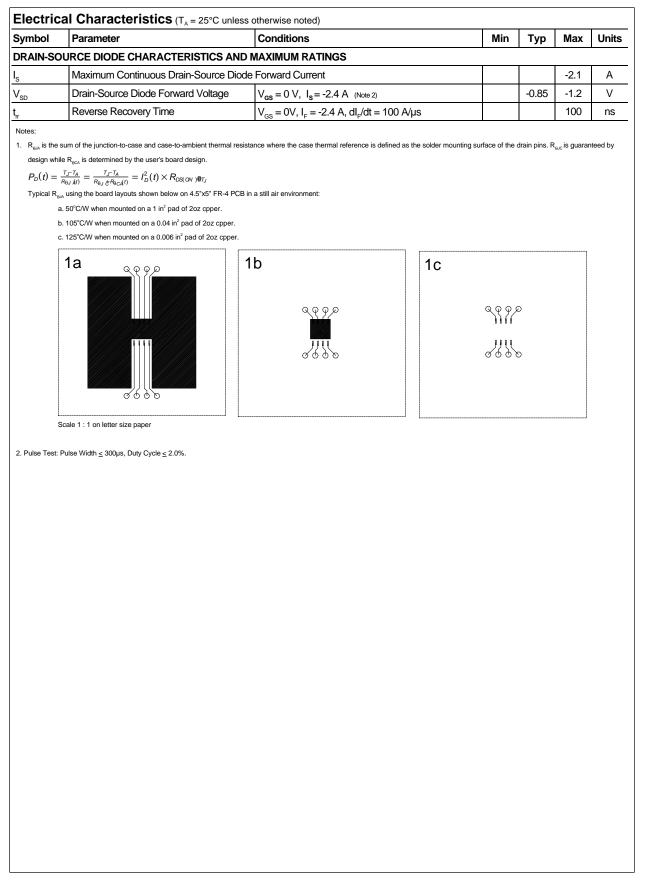
#### Absolute Maximum Ratings T<sub>4</sub> = 25°C unless otherwise noted

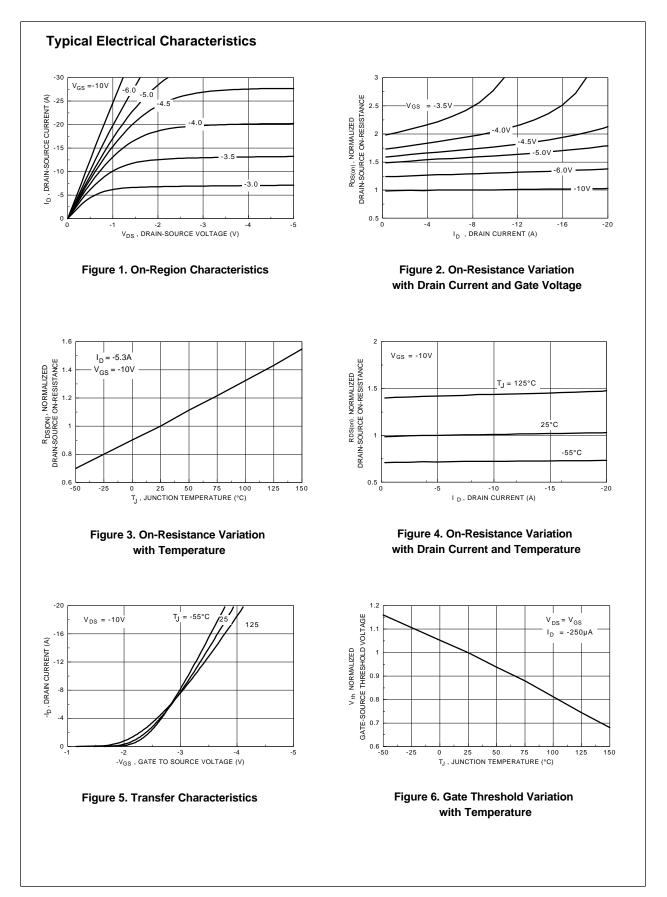
Symbol	Parameter		NDS9430A	Units	
V <sub>DSS</sub>	Drain-Source Voltage		-20	V	
V <sub>GSS</sub>	Gate-Source Voltage		±20	V	
I <sub>D</sub>	Drain Current - Continuous	(Note 1a)	± 5.3	A	
	- Pulsed		±20		
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	2.5	W	
		(Note 1b)	1.2		
		(Note 1c)	1		
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Temperature	Range	-55 to 150	°C	
THERMA	L CHARACTERISTICS				
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Am	bient (Note 1a)	50	°C/W	
R <sub>ØJC</sub>	Thermal Resistance, Junction-to-Ca	SE (Note 1)	25	°C/W	

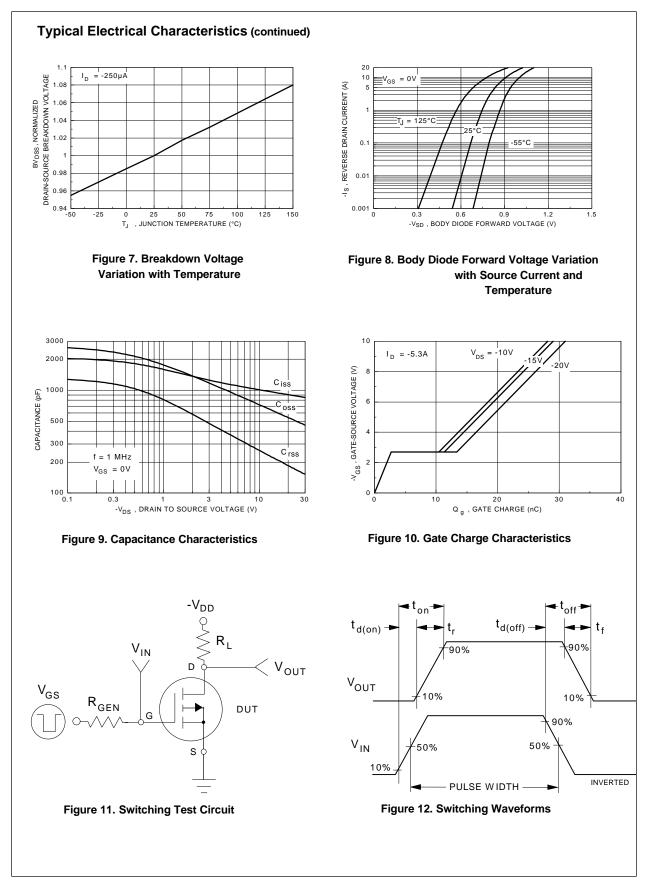
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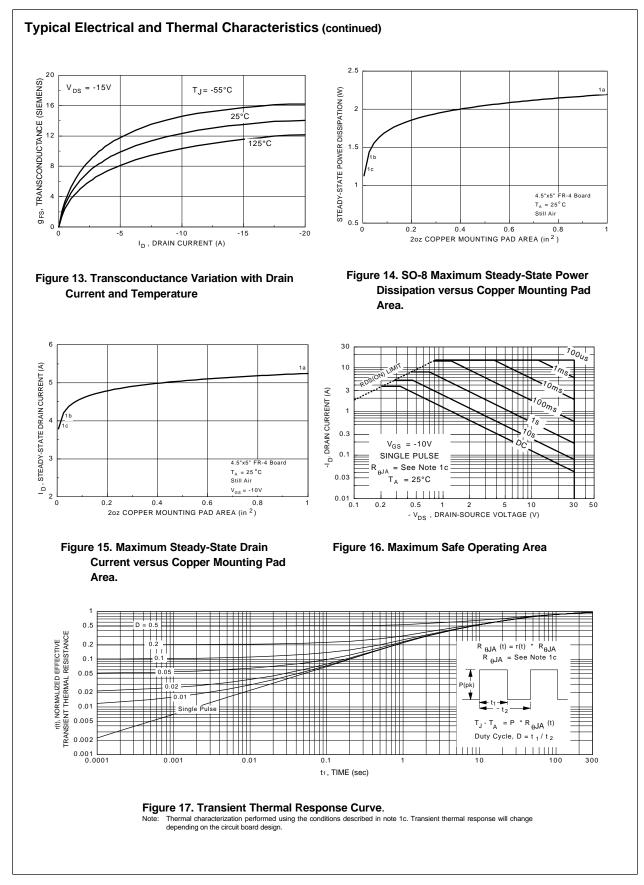
December 1997

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{gs} = 0 V, I_{p} = -250 \mu A$		-20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\rm DS} = -16 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V}$				-1	μA
		$V_{\rm DS} = -10 \text{ V}, V_{\rm GS} = 0 \text{ V}$	$T_{J} = 70^{\circ}C$			-5	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{gg} = 20 \text{ V}, V_{Dg} = 0 \text{ V}$				100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	$V_{gg} = -20 \text{ V}, V_{Dg} = 0 \text{ V}$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250 \mu\text{A}$		-1	-1.4	-3	V
			T <sub>J</sub> = 125°C	-0.7	-1	-2	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{gg} = -10 \text{ V}, I_{p} = -5.3 \text{ A}$			0.038	0.05	Ω
			T <sub>J</sub> = 125°C		0.054	0.1	
		$V_{gs} = -6 V$ , $I_{p} = -4.7 A$			0.046	0.065	
		$V_{gs} = -4.5 \text{ V}, I_{p} = -4.2 \text{ A}$			0.064	0.09	
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$		-15			А
		$V_{GS} = -4.5, V_{DS} = -5V$		-3.6			
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 15 \text{ V}, I_{D} = 5.3 \text{ A}$			10		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1.0 MHz			950		pF
C <sub>oss</sub>	Output Capacitance				610		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				220		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)				_		
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{\text{DD}} = -10 \text{ V}, \text{ I}_{\text{D}} = -1 \text{ A},$ $V_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{GEN}} = 6 \Omega$			10	30	ns
t,	Turn - On Rise Time				18	60	ns
t <sub>D(off)</sub>	Turn - Off Delay Time				80	120	ns
t,	Turn - Off Fall Time				45	100	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = -10 V,$			29	50	nC
Q <sub>gs</sub>	Gate-Source Charge	$I_{\rm D}^{\rm US} = -5.3  \text{A},  V_{\rm GS} = -10  \text{V}$			3		nC
$Q_{gd}$	Gate-Drain Charge				9		nC









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Product selection and	National's proprietary, high cell density,	This page <u>r thit version</u>	Dotted line Design tools
parametric search	DMOS technology. This very high density process is especially tailored to minimize on-		
Cross-reference search	state resistance, provide superior switching		
	performance, and withstand high energy pulses		
technical information	in the avalanche and commutation modes. These devices are particularly suited for low		
buy products	voltage applications such as notebook		
technical support	computer power management and other battery powered circuits where fast switching, low in-		
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Features

- -5.3 A, -20 V

  - .  $R_{DS(ON)} = 0.065\Omega @ V_{GS} = -6$  V
  - $\circ$  R<sub>DS(ON)</sub> = 0.09Ω @ V<sub>GS</sub> = -4.5 V
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- High power and current handling capability in a widely used surface mount package.

## back to top

Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Package marking	Packing method
NDS9430A	Full Production	\$0.96	SOIC	8	\$Y&Z&2&T NDS 9430A	TAPE REEL

\* 1,000 piece Budgetary Pricing

back to top

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